



Schematic Symbol



Description

SPxxxxSC series is a type of semiconductor protection thyristor with surface mount package solution. It is designed to protect baseband equipment from damaging overvoltage transients, such as modems, telephones, line cards, answering machines, FAX machines, T1/E1, xDSL and more.

Features

- Lower capacitance
- Low profile package
- Low on-state voltage
- Max Surge capability 10 × 700 μs @40 Ω: 6 kV
- Excellent capability of absorbing transient surge
- Quick response to surge voltage (ns Level)
- Eliminates overvoltage caused by fast rising transients
- Moisture sensitivity level: Level 1
- Non degenerative
- Flammability Rating: UL 94 V-0
- Halogen free and RoHS compliant

Order Information (Example)

Type	Package	Marking Code	Delivery Form	Delivery Quantity
SP2300SC	DO214AA(SMB)	P23C	13" T&R	3000 PCS

Limiting Values

(T_A = 25 °C, unless otherwise specified)

Symbol	Parameter	Conditions	Min	Max	Unit
I _{PP}	Repetitive peak pulse current	10 / 1000 μs	100	-	A
T _J	Operating Temperature Range	-	-40	125	°C
T _{stg}	Storage Temperature Range	-	-55	150	°C

Surge Rating	I _{PP} (A) min				
	2 / 10 μs ¹	8 / 20 μs ¹ 1.2 / 50 μs ²	10 / 360 μs ¹	5 / 320 μs ¹ 10 / 700 μs ²	10 / 1000 μs ¹
C	500	400	175	150	100

Notes

1. Current waveform in μs¹.
2. Voltage waveform in μs².

Electrical Characteristics

(T_A = 25 °C, unless otherwise specified)

Part Number	IDRM@VDRM		V _s ¹ @I _s		V _T @I _T		I _H	Capacitance ²	Marking Code
	μA	V	V	mA	V	A	mA	pF	
	max		max	max	max	max	min	max	
SP0080SC	1	6	15	800	4	2.2	30	60	P08C
SP0220SC	1	18	30	800	4	2.2	30	60	P22C
SP0300SC	1	25	40	800	4	2.2	30	60	P03C
SP0640SC	1	58	77	800	4	2.2	120	60	P06C
SP0720SC	1	65	87	800	4	2.2	120	50	P07C
SP0900SC	1	75	98	800	4	2.2	120	50	P09C
SP1100SC	1	90	130	800	4	2.2	120	50	P11C
SP1300SC	1	120	160	800	4	2.2	120	50	P13C
SP1500SC	1	140	180	800	4	2.2	120	45	P15C
SP1800SC	1	170	220	800	4	2.2	120	45	P18C
SP2300SC	1	190	260	800	4	2.2	120	40	P23C
SP2600SC	1	220	300	800	4	2.2	120	40	P26C
SP3100SC	1	275	350	800	4	2.2	120	35	P31C
SP3500SC	1	320	400	800	4	2.2	120	35	P35C
SP3800SC	1	340	450	800	4	2.2	120	35	P38C
SP4200SC	1	400	520	800	4	2.2	100	35	P42C
SP4800SC	1	440	580	800	4	2.2	100	50	P48C

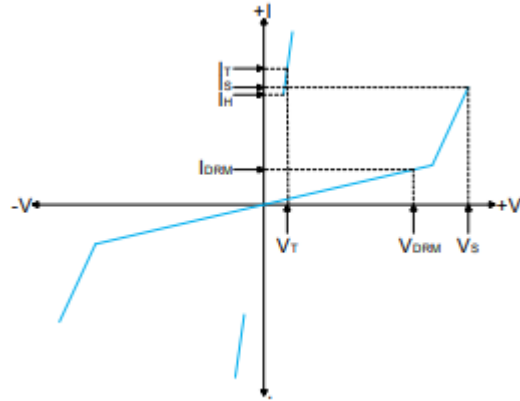
Notes

1. V_s is measured at 100 kV / S.
2. Off-state capacitance is measured in VDC=2 V, VRMS=1 V, f=1 MHz.

Electrical Characteristics

($T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Symbol	Parameter
VDRM	Peak off-state voltage
IDRM	Off-state current
V_S	Switching voltage
I_S	Switching current
V_T	On-state voltage
I_T	On-state current
I_H	Holding current
C_O	Off-state capacitance



Performance Curve for Reference

($T_A=25\text{ }^\circ\text{C}$ unless otherwise noted)

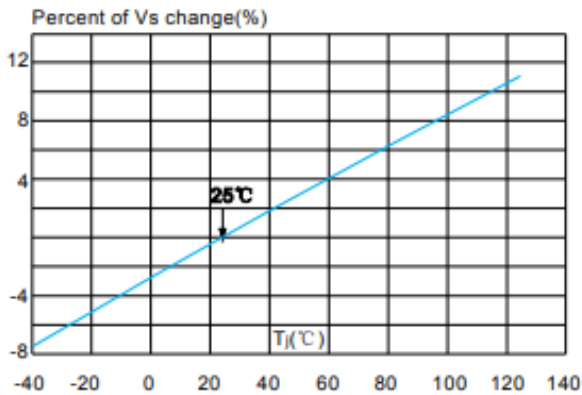


FIGURE 1

Normalized V_S . Change V_S . Junction Temperature

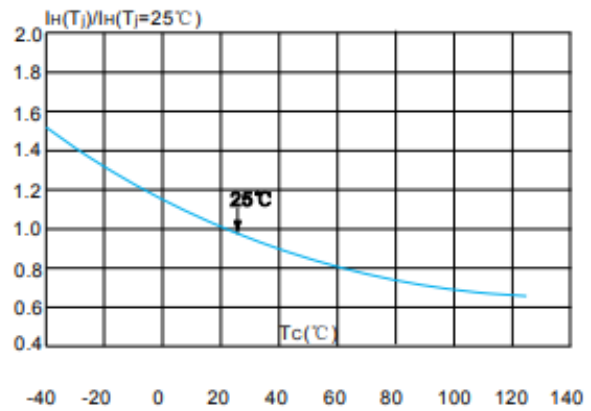


FIGURE 2

Normalized DC Holding Current VS. Case Temperature

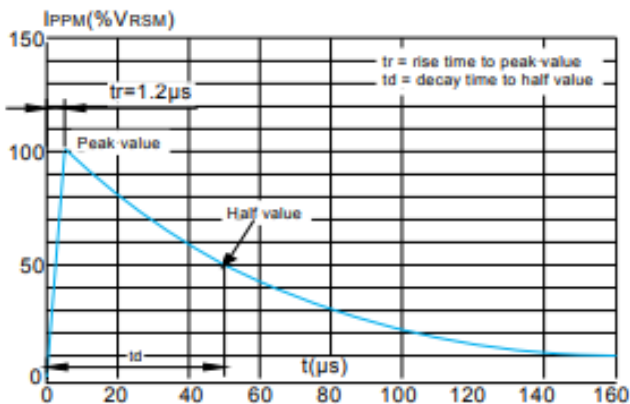
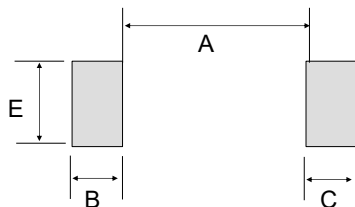
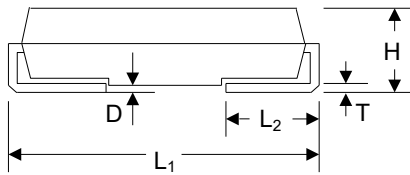
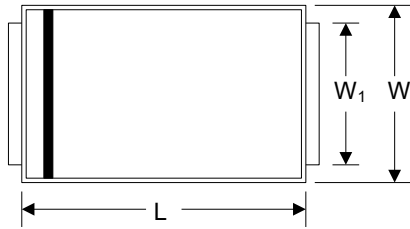


FIGURE 3

$t_r \times t_d$ Pulse Waveform

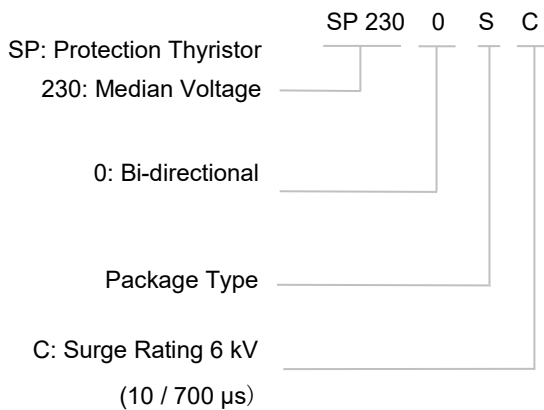
Package Dimensions



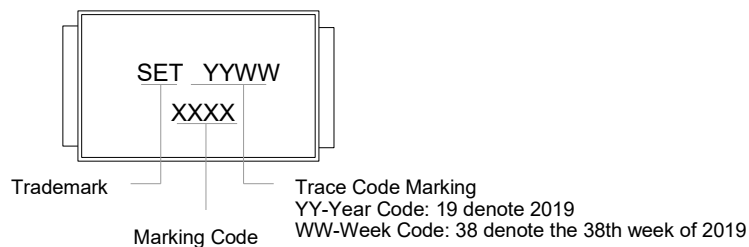
(Mounting Pad Layout)

Symbol	Millimeters		Inches	
	Min.	Max.	Min.	Max.
L	4.060	4.750	0.160	0.187
W	3.300	3.940	0.130	0.155
W ₁	1.930	2.200	0.076	0.086
H	1.990	2.610	0.078	0.103
T	0.152	0.305	0.006	0.012
L ₁	5.210	5.590	0.205	0.220
L ₂	0.760	1.520	0.030	0.060
D	-	0.203	-	0.008
A	-	2.740	-	0.107
B	2.160	-	0.085	-
C	2.160	-	0.085	-
E	2.260	-	0.089	-

Part Numbering System (Example)



Marking



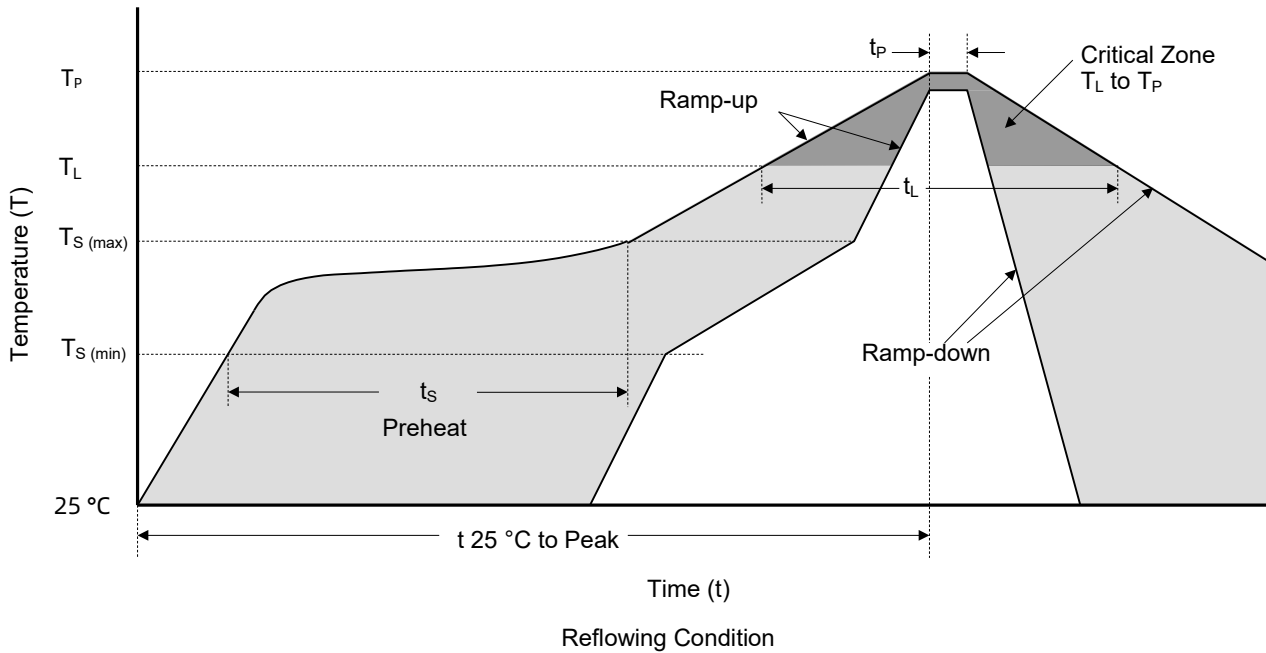
Packaging Information

Tape	Symbol	Dimension (mm)
	W	12.00+0.30/-0.10
	P ₀	4.00±0.10
	P ₁	8.00±0.10
	P ₂	2.00±0.05
	D ₀	1.55±0.05
	D ₁	1.55±0.05
	E	1.75±0.1
	F	5.50±0.05
	A ₀	3.78±0.10
	B ₀	5.65±0.15
	K ₀	2.70±0.10
	T	0.30±0.05

Reel Size	Symbol	Dimension (mm)
	A	330 mm
	C	13.2 mm
	W ₁	12.5 mm

Part Number	Package	QTY (Reel)	Packaging Option	Packaging Specification
SPxxxxSC	DO-214AA	3000 PCS	Tape & Reel – 12mm tape/13" reel	EIA STD RS-481

Soldering Parameters



Reflow Soldering Parameters		Lead-Free Assembly
Pre-heat	Temperature Min ($T_{S (min)}$)	150 °C
	Temperature Max ($T_{S (max)}$)	200 °C
	Time (min to max) (t_s)	60 ~ 120 seconds
Average Ramp Up Rate (Liquidus Temp (T_L) to Peak Temp (T_P))		3 °C / second max.
$T_s (max)$ to T_L -Ramp-up Rate		3 °C / second max.
Reflow	Temperature (T_L)	217 °C
	Time (t_L)	60 ~ 150 seconds
Peak Temperature (T_P)		260 ^{+0/-5} °C
Time of within 5 °C of Actual Peak Temperature (t_p)		30 seconds
Ramp-down Rate		6 °C / second max.
Time From 25 °C to Peak Temperature		8 Minutes max.
Do Not Exceed		260 °C



ATTENTION

Usage

1. TSS must be operated in the specified ambient temp..
2. Do not clean the TSS with strong polar solvent such as ketone, esters, benzene and halogenated hydrocarbon, to avoid damaging the encapsulating layer.
3. Please do not apply severe vibration, shock or pressure to TSS, to avoid element cracking.

Replacement

1. If TSS is visually damaged, please replace it.
2. TSS is a non-repairable product. For safety sake, please use equivalent TSS for replacement.

Storage

1. Storage Temp. Range: (-55 to 150) °C.
2. Do not store the TSS at the high temp., high humidity or corrosive gas environment, to avoid influencing the solder- ability of the lead wires. The product shall be used up within 1 year after receiving the goods.

Environmental Conditions

1. TSS should not be exposed to the open air, nor direct sunshine.
2. TSS should avoid rain, water vapor or other condition of high temp. and high humidity.
3. TSS should avoid sand dust, salt mist, or other harmful gases.

Max. Typical Capacitance of TSS

1. The typical capacitance of TSS is listed in the specifications. Designers may refer to it when designing TSS in High frequency circuit.

Installation Mechanical Stress

1. Do not knock TSS when installing, to avoid mechanical damage.
2. Please do not apply severe vibration, shock or pressure to TSS, to avoid surface resin or element cracking.